

SN54LS31, SN74LS31 DELAY ELEMENTS

SDLS157 - DECEMBER 1983 - REVISED MARCH 1988

- Delay Elements for Generating Delay Lines
- Inverting and Non-inverting Elements
- Buffer NAND Elements Rated at I_{OL} of 12/24 mA
- PNP Inputs Reduce Fan-In ($I_{IL} = -0.2$ mA MAX)
- Worst Case MIN/MAX Delays Guaranteed Across Temperature and V_{CC} Ranges

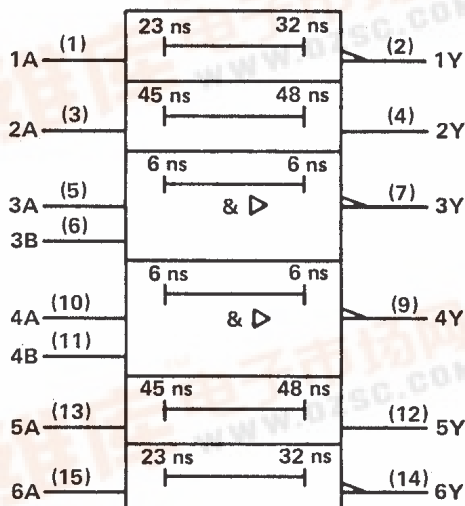
description

These 'LS31 delay elements are intended to provide well-defined delays across both temperature and V_{CC} ranges. Used in cascade, a limitless range of delay gating is possible.

All inputs are PNP with I_{IL} MAX of -0.2 mA. Gates 1, 2, 5, and 6 have standard Low-Power Schottky output sink current capability of 4 and 8 mA I_{OL} . Buffers 3 and 4 are rated at 12 and 24 mA.

The SN54LS31 is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74LS31 is characterized for operation from 0°C to 70°C .

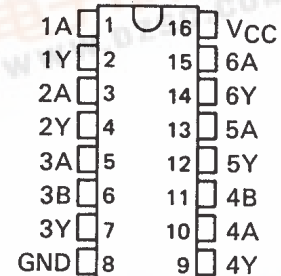
logic symbol†



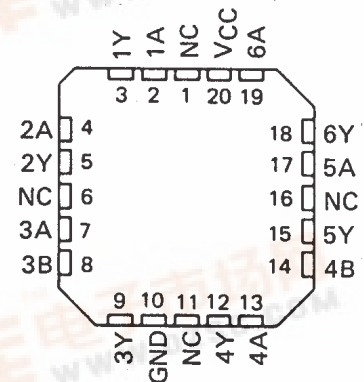
† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

SN54LS31 . . . J OR W PACKAGE
SN74LS31 . . . D OR N PACKAGE
(TOP VIEW)



SN54LS31 . . . FK PACKAGE
(TOP VIEW)



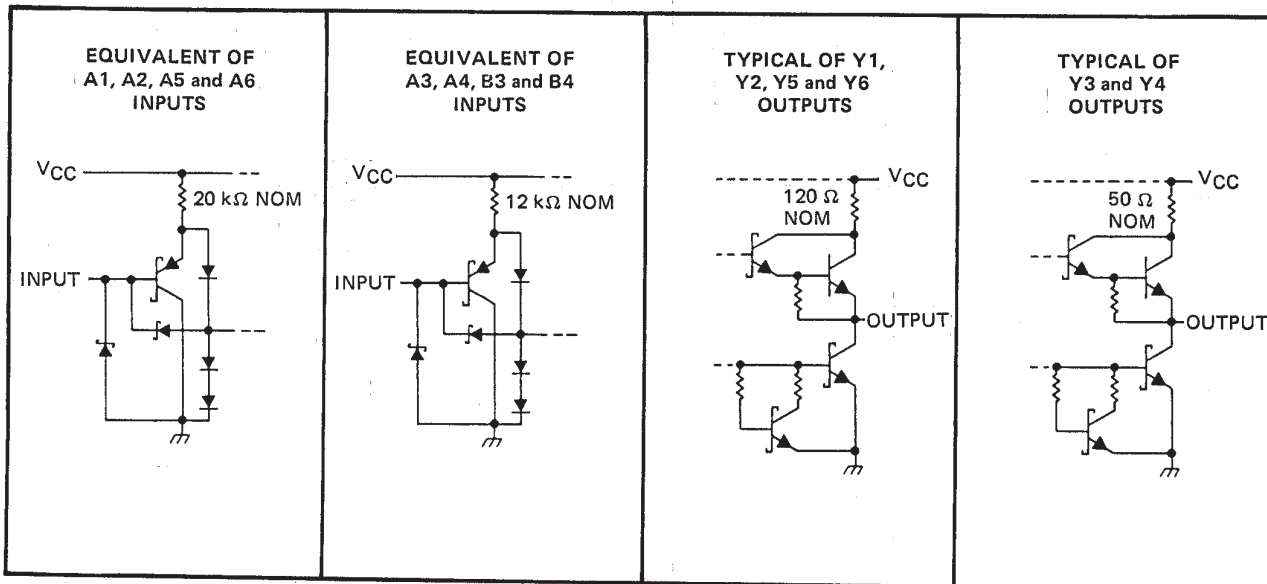
NC - No internal connection



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Delay Element	Logic	Typical Delays			Rated I _{OL}
		t _{PLH}	t _{PHL}	AVG.	
Gates 1 and 6	Inverting	32 ns	23 ns	27.5 ns	4 and 8 mA
Gates 2 and 5	Non-Inverting	45 ns	48 ns	46.5 ns	4 and 8 mA
Buffers 3 and 4	2-Input NAND	6 ns	6 ns	6 ns	12 and 24 mA



absolute maximum ratings over operating free air temperature range (unless otherwise noted)

Supply voltage, V _{CC} (See Note 1)	7 V
Input voltage, V _I : All inputs	7 V
Operating free-air temperature range: SN54LS31	– 55°C to 125°C
SN74LS31	0°C to 70°C
Storage temperature range	– 65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

recommended operating conditions

	SN54LS31			SN74LS31			UNIT
	MIN	NOM	MAX	MIN	NOM	MAX	
V _{CC} Supply voltage	4.5	5	5.5	4.75	5	5.25	V
V _{IH} High-level input voltage	2			2			V
V _{IL} Low-level input voltage			0.7			0.8	V
I _{OH} High-level output current	Y3, Y4 outputs		– 1.2	Y3, Y4 outputs		– 1.2	mA
	All other outputs		– 0.4	All other outputs		– 0.4	
I _{OL} Low-level output current	Y3, Y4 outputs		12	Y3, Y4 outputs		24	mA
	All other outputs		4	All other outputs		8	
T _A Operating free-air temperature	– 55		125	0		70	°C

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS†		SN54LS31		SN74LS31		UNIT		
			MIN	TYP‡	MAX	MIN		TYP‡	MAX
V_{IK}	$V_{CC} = \text{MIN}, I_I = -18 \text{ mA}$		-1.5		-1.5		V		
V_{OH}	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = \text{MAX}$	Y3, Y4	$I_{OH} = -1.2 \text{ mA}$		2.4	3.1	2.4	3.1	V
		Others	$I_{OH} = -0.4 \text{ mA}$		2.5	3.1	2.7	3.1	
V_{OL}	$V_{CC} = \text{MIN}, V_{IH} = 2 \text{ V}, V_{IL} = \text{MAX}$	Y3, Y4	$I_{OL} = 12 \text{ mA}$		0.25	0.4	0.25	0.4	V
			$I_{OL} = 24 \text{ mA}$				0.35	0.5	
		Others	$I_{OL} = 4 \text{ mA}$		0.25	0.4	0.25	0.4	
			$I_{OL} = 8 \text{ mA}$				0.35	0.5	
I_I	$V_{CC} = \text{MAX}, V_I = 7 \text{ V}$		0.1		0.1		mA		
I_{IH}	$V_{CC} = \text{MAX}, V_I = 2.7 \text{ V}$		20		20		μA		
I_{IL}	$V_{CC} = \text{MAX}, V_I = 0.4 \text{ V}$		-0.2		-0.2		mA		
$I_{OS}§$	$V_{CC} = \text{MAX}, A3, A4, B3, B4 = 0 \text{ V}$		Y3, Y4		-30	-130	-30	-130	mA
	$V_{CC} = \text{MAX}, A1, A6 = 0 \text{ V}, A2, A5 = 4.5 \text{ V}$		Y1, Y2, Y5, Y6		-20	-100	-20	-100	
I_{CC}	I_{CCH}	$V_{CC} = \text{MAX}, A2, A5 = 4.5 \text{ V},$ all other inputs 0 V		2.3	4	2.3	4	mA	
	I_{CCL}	$V_{CC} = \text{MAX}, A2, A5 = 0 \text{ V},$ all other inputs 4.5 V		13	20	13	20		

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at $V_{CC} = 5 \text{ V}, T_A = 25^\circ\text{C}$.

§ Not more than one output should be shorted at a time and the duration of the short-circuit should not exceed one second.

switching characteristics, (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LS31		SN74LS31		UNIT	
			MIN	TYP	MAX	MIN		TYP
t_{PLH}	A1, A6	Y1, Y6	15		70	22	65	ns
t_{PHL}			9		50	13	45	ns
t_{PLH}	A2, A5	Y2, Y5	22		90	31	80	ns
t_{PHL}			20		105	30	95	ns
t_{PLH}	A3, B3, A4, Y4	Y3, Y4	2		20	2	15	ns
t_{PHL}			2		20	2	15	ns

NOTE 2: $V_{CC} = \text{MIN to MAX}$

$R_L = 667 \Omega, C_L = 45 \text{ pF}$ for Y3 and Y4.

$R_L = 2 \text{ k}\Omega, C_L = 15 \text{ pF}$ for Y1, Y2, Y5 and Y6.

$T_A = \text{MIN to MAX}$

Load circuits and voltage waveforms are shown in Section 1.

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